

Applicant : Chika Amishima, et al.

Serial No. : 10/583,644

Filed : June 20, 2006

For : POLYAMIDE ACID RESIN CONTAINING

UNSATURATED GROUP, PHOTOSENSTIVE RESIN COMPOSITION USING SAME, AND CURED

PRODUCT THEREOF

Examiner : Fang, Shane

Art Unit : 1796

Confirmation

No. : 3737

Attorney

Docket No. : 576P091

Customer No. : 42754

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

on August 3, 2009 (Da

Name of applicant, assignee, or Registered

Representative

Signature

August 3, 3

Date

Sir:

AMENDMENT

In response to the Office Action dated May 12, 2009, Please amend the above-identified application as follows:

Remarks begin on page 2 of this paper.

Amendments to the claims begin on page 14 of this paper.

An **Appendix**, containing a partial translation of JP2001-192431, begins on page 21 of this paper.